COMBINED DECLARATION AND POWER OF ATTORNEY

As the below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name and that I believe I am an original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

CHIP STRUCTURE

the specification of w	vhich			
X is attached here was filed on as Application	······································	and was amended on	·	
specification, including lacknowledge application in accord lhereby claim foreign application(s	ng the claims, as amenthe duty to disclose in ance with Title 37, Conforeign priority benefit or inventorion for patent or inventorion for patent or inventorionity is claimed:	d and understood the content nded by any amendment refern nformation which is material to de of Federal Regulations, § 1 fits under Title 35, United Sta r's certificate listed below and intor's certificate having a filin	ed to above. the patental .56(a). ates Code, § have also ide	bility of this 119 of any ntified below
Number	Country	Date Filed(yyyy/mm/dd)	Yes	No
92115490	Taiwan, R.O.C.	2003/06/09	X	
	in the Patent and Trac) and/or agent(s) to prosecut demark Office connected there		ation and to

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COMBINED DECLARATION AND POWER OF ATTORNEY CONTINUED

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patents issued thereon.

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